

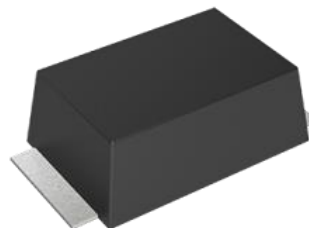
## Thyristor Surge Suppressor

Version: A1 2017-12-11

### Features

- Low leakage current
- Low residual voltage
- Low Capacitance (under 25pF)
- Quick response to surge voltage (nS Level)
- Moisture sensitivity level: level 1
- Non degenerative

### Exterior

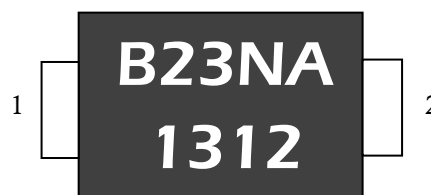


SMB-F


### Application Information

- xDSL

### Package (top view)



### Agency Approvals

Icon	Description
<b>RoHS</b>	Compliance with 2011/65/EU
<b>HF</b>	Compliance with IEC61249-2-21:2003
	UL Certificated E232249

### Schematic Symbol



### Part Number and Electrical Parameter

Part Number	I <sub>DRM</sub> @V <sub>DRM</sub>		V <sub>S</sub> <sup>①</sup> @ I <sub>S</sub>		V <sub>T</sub> @ I <sub>T</sub>		I <sub>H</sub>	Co <sup>②</sup>
	μA	V	V	mA	V	A	mA	pF
	MAX		MAX		MAX		MIN	MAX
BS2300N-A-F	1	190	260	800	4	2.2	150	25

Absolute maximum ratings measured at T<sub>A</sub> = 25°C RH = 45%-75% (unless otherwise noted).

① V<sub>S</sub> is measured at 100KV/S

② Off-state Capacitance is measured at V<sub>DC</sub>=2V, V<sub>RMS</sub>=1V, f=1MHz

## Thyristor Surge Suppressor

Version: A1 2017-12-11

### Part Numbering System

BS 2300 N A -F  
(1) (2) (3) (4) (5)

- (1) Bencent Semiconductor Surge Arrester
- (2) Off-state Voltage, e.g. 2300=230×10<sup>0</sup>=230V
- (3) Package: SMB
- (4) Rating Surge Voltage: 3KV (10/700μs)
- (5) Flat feet

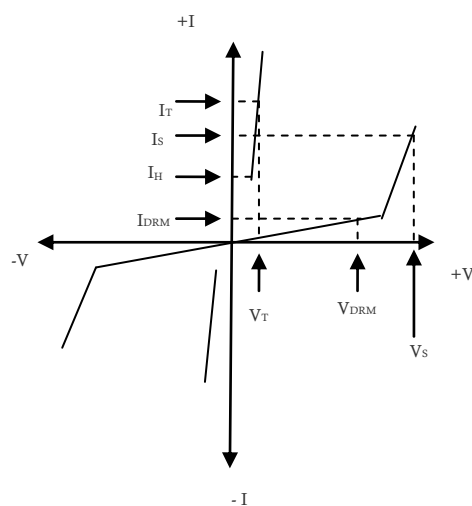
### Mark



B23NA: Part Number  
1312: December, 2013

### V-I Curve

Parameters	Definition
V <sub>DRM</sub>	Peak Off-state Voltage
I <sub>DRM</sub>	Off-state Current
V <sub>S</sub>	Switching Voltage
I <sub>S</sub>	Switching Current
I <sub>H</sub>	Holding Current
V <sub>T</sub>	On-state Voltage
I <sub>T</sub>	On-state Current
C <sub>o</sub>	Off-state Capacitance



### Surge Ratings

Current Waveform	5/320μs*
Voltage Waveform	10/700μs*
I <sub>pp</sub>	75A

-Peak pulse current rating (I<sub>pp</sub>) is repetitive and guaranteed for the life of the product;

-Bencent only makes the test for 5/320μs@75A\* (10/700μs@3KV), but for other IPP value derived from experience is just for reference only. Bencent will not take any obligation for these parameters, so before applying our parts, please make sure to verify the parameters listed in the above table.

### Thermal Considerations

Symbol	Parameter	Value	Unit
T <sub>J</sub>	Operating Junction Temperature Range	-40 to +150	°C
T <sub>S</sub>	Storage Temperature Range	-60 to +150	°C

### Physical Characteristics

Lead Material	Copper Alloy
Body Material	UL recognized epoxy meeting flammability classification 94V-0
Terminal Finish	100% Matte-Tin Plated

## Thyristor Surge Suppressor

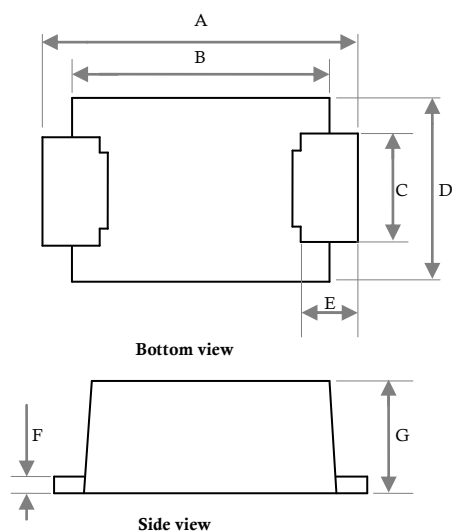
Version: A1 2017-12-11

### Environmental Characteristics

Testing Items	Technical Standards
High Temperature Reverse Bias Test	Temperature: $150\pm 3^{\circ}\text{C}$ , Bias= $80\%V_{\text{DRM}}$ Time: 168H
High Temperature Life Test	Temperature: $150^{\circ}\text{C}$ Time: 168H
High-low Temperature Cycle Test	Temperature: From $-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$ Dwell time: 30min, 10-100 cycles
High Temperature & High Humidity Test	Temperature: $85^{\circ}\text{C}$ Humidity: 85% Test time: 168H
Pressure Cooker Test	Temperature: $121^{\circ}\text{C}$ , 2atm. Humidity: 100% Test time: 24H
Resistance of Soldering Heat	Temperature: $260\pm 5^{\circ}\text{C}$ Time of dip soldering: 10s, 3times

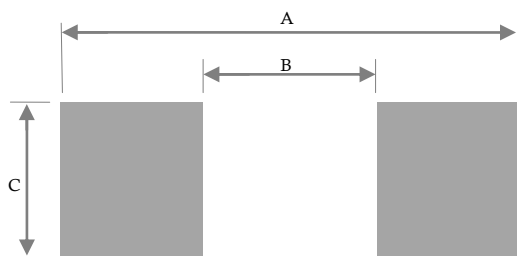
Note: The above testing items can be specified by customers by contacting Bencent service

### Product Dimensions



REF	mm	inch
A	$5.4\pm 0.3$	$0.213\pm 0.012$
B	$4.4\pm 0.2$	$0.173\pm 0.008$
C	$2.0\pm 0.1$	$0.079\pm 0.004$
D	$3.3\pm 0.3$	$0.130\pm 0.012$
E	$0.8\pm 0.3$	$0.032\pm 0.012$
F	$0.25\pm 0.05$	$0.010\pm 0.002$
G	$2\pm 0.3$	$0.079\pm 0.012$

### Recommended Soldering Pad



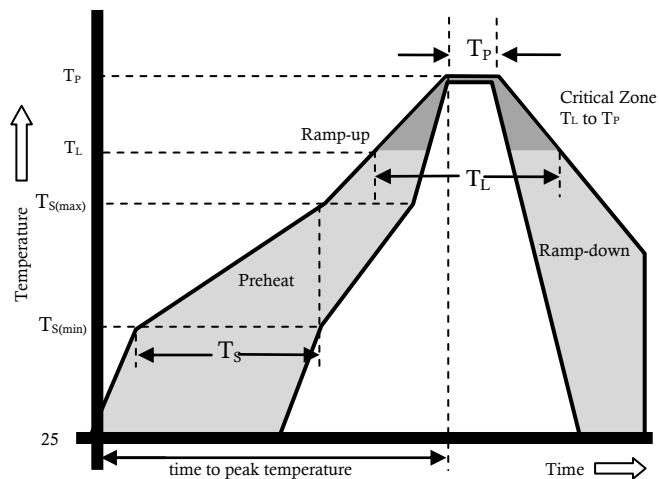
REF	mm	inch
A	6.4	0.252
B	3.4	0.134
C	2.75	0.108

## Thyristor Surge Suppressor

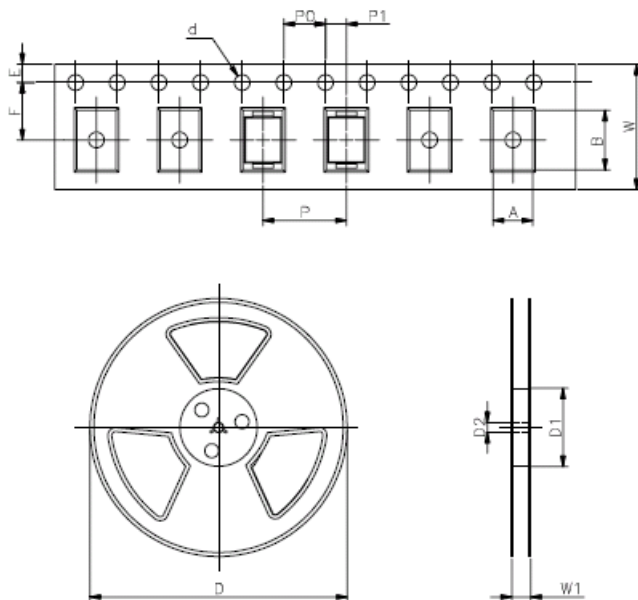
Version: A1 2017-12-11

### Reflow Profile

Reflow Condition		Pb-Free Assembly
Pre Heat	Temperature Min.	+150°C
	Temperature Max.	+200°C
	Time (Min to Max)	60 – 180 secs.
Average ramp up rate (Liquidus Temp (T <sub>L</sub> ) to peak)		3°C/sec. Max.
Ts(max) to T <sub>L</sub> - Ramp-up Rate		3°C/sec. Max.
Reflow	- Temperature (T <sub>L</sub> ) (Liquidus)	+217°C
	- Temperature (T <sub>L</sub> )	60 – 150 secs.
Peak Temp (T <sub>P</sub> )		+(260+0/-5) °C
Time within 5°C of actual Peak Temp (T <sub>P</sub> )		20 – 40secs.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to peak Temp (T <sub>P</sub> )		8 min. Max.
Do not exceed		+260°C



### Package Reel Information



REF	mm	inch
A	3.65+/-0.3	0.144+/-0.012
B	5.69+/-0.3	0.244+/-0.012
d	1.5+/-0.1	0.059+/-0.004
D	330.0	13.0
D1	100+/-3	3.937+/-0.118
D2	13+/-0.3	0.512+/-0.012
E	1.5+/-0.2	0.059+/-0.008
F	5.65+/-0.2	0.222+/-0.008
P	8.0+/-0.2	0.315+/-0.008
P0	4.0+/-0.2	0.157+/-0.008
P1	2.0+/-0.2	0.079+/-0.008
W	12.0+/-0.2	0.472+/-0.008
W1	16.8+/-2.0	0.661+/-0.079

Outline	Reel (pcs)	Per Carton (pcs)	Reel Diameters (mm)	Carton Size(mm)		
				L	W	H
Taping	3,000	48,000	330	360	360	380